

TC74LCX273F, TC74LCX273FW, TC74LCX273FT, TC74LCX273FK**Low-Voltage Octal D-Type Flip-Flop with Clear with 5-V Tolerant Inputs and Outputs**

The TC74LCX273F/FW/FT/FK is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low-power dissipation.

The device is designed for low-voltage (3.3 V) V_{CC} applications, but it could be used to interface to 5-V supply environment for both inputs and outputs.

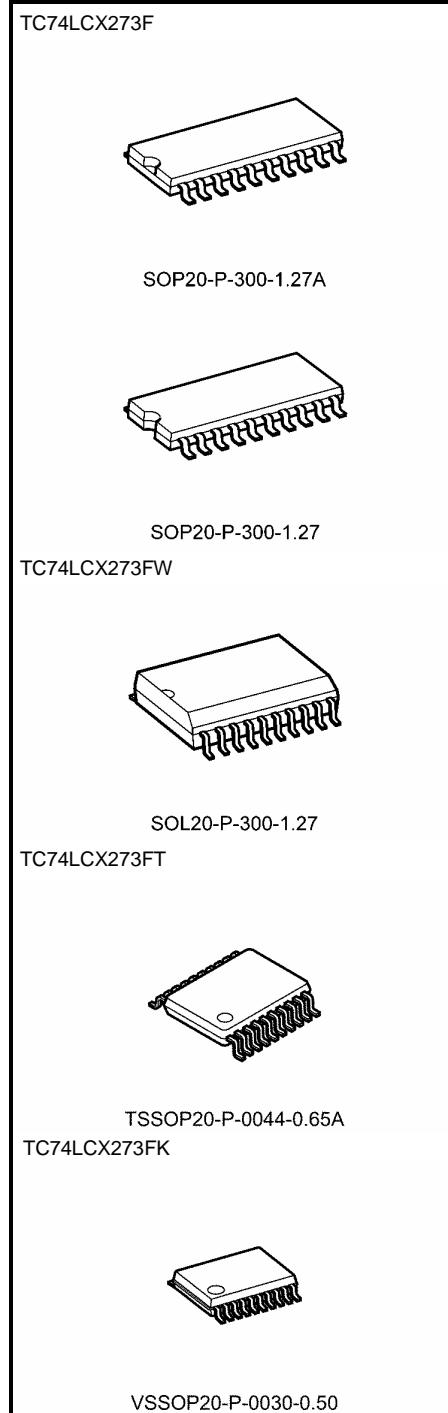
This 8 bit D-type flip-flop is controlled by a clock input (CK) and a clear input ($\overline{\text{CLR}}$). When the $\overline{\text{CLR}}$ input is low, the eight outputs are at a low logic level.

All inputs are equipped with protection circuits against static discharge.

Features

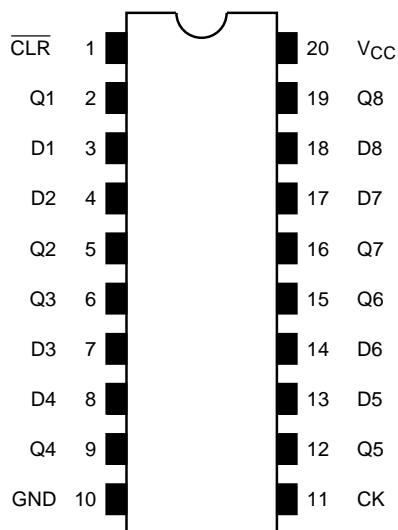
- Low-voltage operation: V_{CC} = 2.0 to 3.6 V
- High-speed operation: t_{pd} = 8.5 ns (max) (V_{CC} = 3.0 to 3.6 V)
- Output current: |I_{OH}|/I_{OL} = 24 mA (min) (V_{CC} = 3.0 V)
- Latch-up performance: ± 500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- Power-down protection is provided on all inputs and outputs
- Pin and function compatible with the 74 series
(74AC/VHC/HC/F/ALS/LS etc.) 273 type

Note: xxxFW (JEDEC SOP) is not available in Japan.

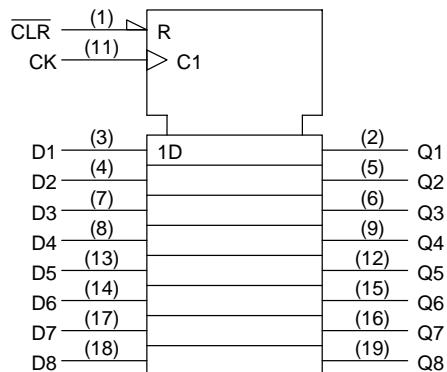
**Weight**

SOP20-P-300-1.27A	: 0.22 g (typ.)
SOP20-P-300-1.27	: 0.22 g (typ.)
SOL20-P-300-1.27	: 0.46 g (typ.)
TSSOP20-P-0044-0.65A	: 0.08 g (typ.)
VSSOP20-P-0030-0.50	: 0.03 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol

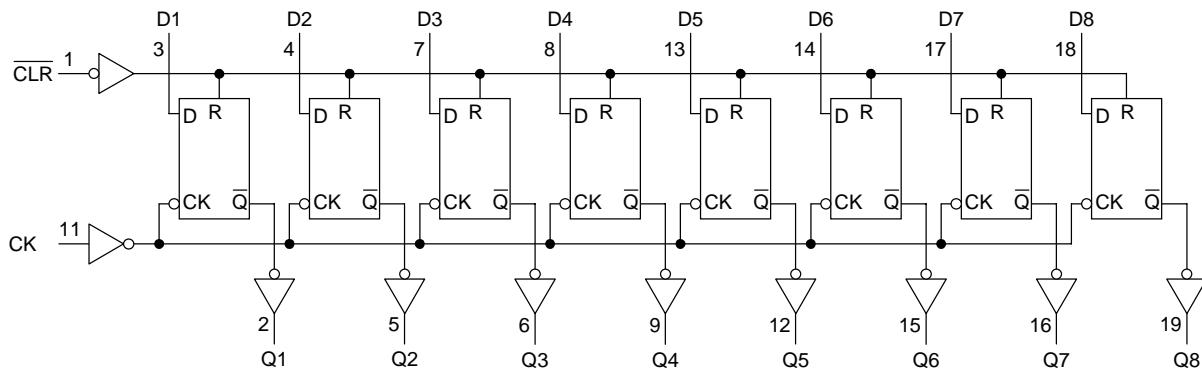


Truth Table

Inputs			Outputs	Function
CLR	D	CK	Q	
L	X	X	L	Clear
H	L	↑	L	—
H	H	↑	H	—
H	X	↓	Qn	No change

X: Don't care

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	−0.5 to 7.0	V
DC input voltage	V _{IN}	−0.5 to 7.0	V
DC output voltage	V _{OUT}	−0.5 to 7.0 (Note 2)	V
		−0.5 to V _{CC} + 0.5 (Note 3)	
Input diode current	I _{IK}	−50	mA
Output diode current	I _{OK}	±50 (Note 4)	mA
DC output current	I _{OUT}	±50	mA
Power dissipation	P _D	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{STG}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: V_{CC} = 0 V

Note 3: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 4: V_{OUT} < GND, V_{OUT} > V_{CC}

Recommended Operating Conditions (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V _{CC}	2.0 to 3.6	V
		−1.5 to 3.6 (Note 2)	
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to 5.5 (Note 3)	V
		0 to V _{CC} (Note 4)	
Output current	I _{OH} /I _{OL}	±24 (Note 5)	mA
		±12 (Note 6)	
Operating temperature	T _{opr}	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V

Note 1: The recommended operating conditions are required to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Note 2: Data retention only

Note 3: V_{CC} = 0 V

Note 4: High or low state

Note 5: V_{CC} = 3.0 to 3.6 V

Note 6: V_{CC} = 2.7 to 3.0 V

Note 7: V_{IN} = 0.8 to 2.0 V, V_{CC} = 3.0 V

Electrical Characteristics**DC Characteristics (Ta = -40 to 85°C)**

Characteristics		Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit	
Input voltage	H-level				2.7 to 3.6	2.0		
	L-level	V _{IL}		2.7 to 3.6	—	0.8		
Output voltage	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	V	
				I _{OH} = -12 mA	2.7	2.2		
				I _{OH} = -18 mA	3.0	2.4		
				I _{OH} = -24 mA	3.0	2.2		
	L-level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	2.7 to 3.6	—	V	
				I _{OL} = 12 mA	2.7	—		
				I _{OL} = 16 mA	3.0	—		
				I _{OL} = 24 mA	3.0	—		
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V	2.7 to 3.6	—	±5.0	μA	
Power-off leakage current		I _{OFF}	V _{IN} /V _{OUT} = 5.5 V	0	—	10.0	μA	
Quiescent supply current	I _{CC}		V _{IN} = V _{CC} or GND	2.7 to 3.6	—	10.0	μA	
			V _{IN} = 3.6 to 5.5 V	2.7 to 3.6	—	±10.0		
Increase in I _{CC} per input	ΔI _{CC}		V _{IN} = V _{CC} - 0.6 V	2.7 to 3.6	—	500		

AC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{MAX}	(Figure 1, Figure 2)		2.7	—	—	MHz
				3.3 ± 0.3	150	—	
Propagation delay time (CK-Q)	t _{PLH} t _{PHL}	(Figure 1, Figure 2)		2.7	—	9.5	ns
				3.3 ± 0.3	1.5	8.5	
Propagation delay time (CLR-Q)	t _{PHL}	(Figure 1, Figure 3)		2.7	—	9.5	ns
				3.3 ± 0.3	1.5	8.5	
Minimum pulse width (CK)	t _w (H) t _w (L)	(Figure 1, Figure 2)		2.7	3.3	—	ns
				3.3 ± 0.3	3.3	—	
Minimum pulse width (CLR)	t _w (L)	(Figure 3)		2.7	3.3	—	ns
				3.3 ± 0.3	3.3	—	
Minimum setup time	t _s	(Figure 1, Figure 2)		2.7	2.5	—	ns
				3.3 ± 0.3	2.5	—	
Minimum hold time	t _h	(Figure 1, Figure 2)		2.7	1.5	—	ns
				3.3 ± 0.3	1.5	—	
Minimum removal time	t _{rem}	(Figure 4)		2.7	2.5	—	ns
				3.3 ± 0.3	2.0	—	
Output to output skew	t _{osLH} t _{osHL}	(Note)		2.7	—	—	ns
				3.3 ± 0.3	—	1.0	

Note: Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Dynamic Switching Characteristics(Ta = 25°C, input: t_r = t_f = 2.5 ns, C_L = 50 pF, R_L = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Unit
Input capacitance	C _{IN}	—	3.3	7	pF
Output capacitance	C _{OUT}	—	0	8	pF
Power dissipation capacitance	C _{PD}	f _{IN} = 10 MHz (Note)	3.3	25	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

$$I_{CC} (\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

AC Test Circuit

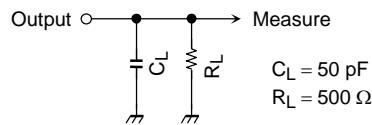


Figure 1

AC Waveform

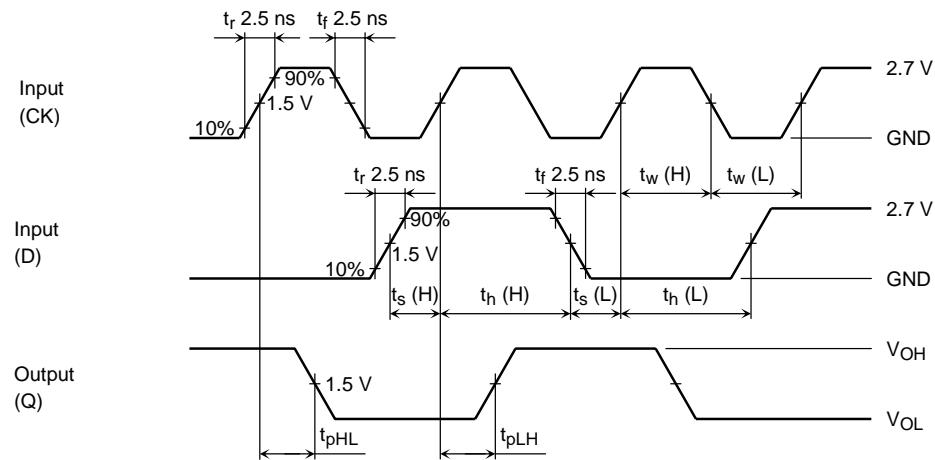


Figure 2 t_{pLH} , t_{pHL} , t_w , t_s , t_h

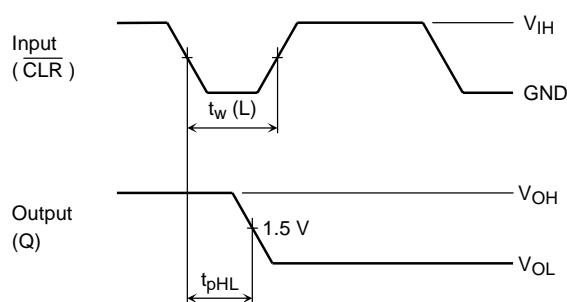


Figure 3 t_{pHL}

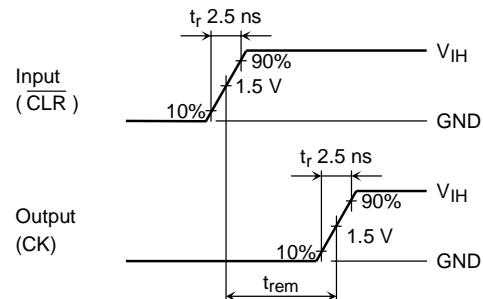
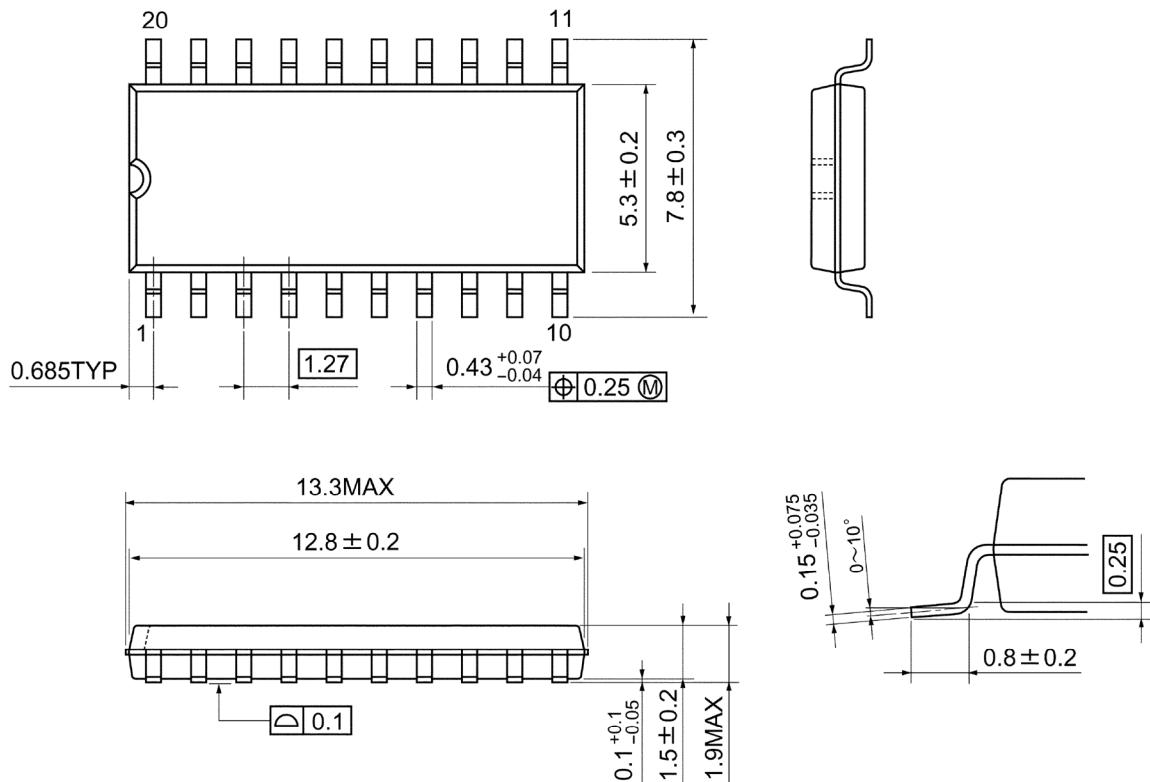


Figure 4 t_{rem}

Package Dimensions

SOP20-P-300-1.27A

Unit: mm

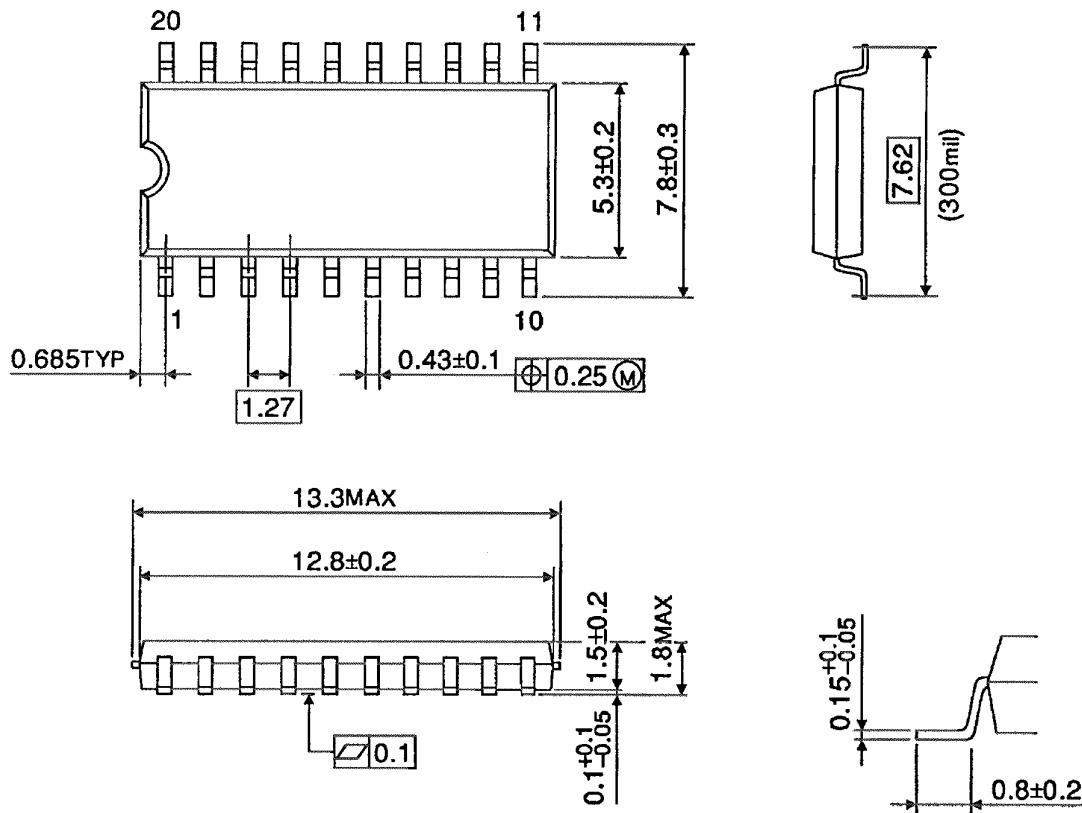


Weight: 0.22 g (typ.)

Package Dimensions

SOP20-P-300-1.27

Unit : mm

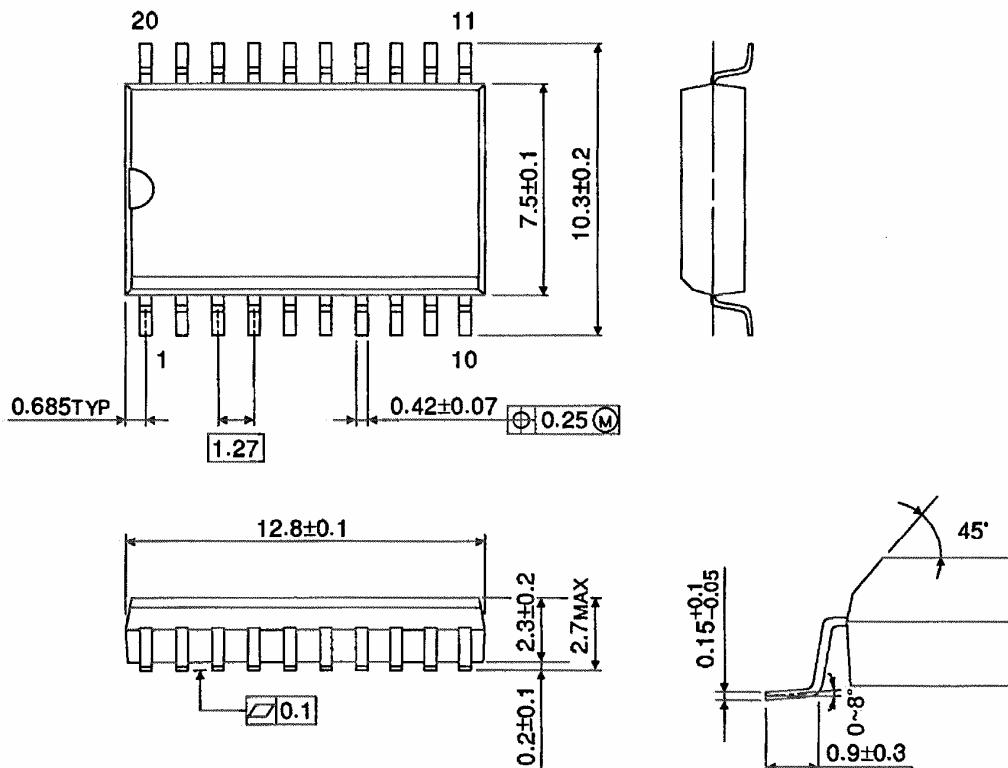


Weight: 0.22 g (typ.)

Package Dimensions (Note)

SOL20-P-300-1.27

Unit : mm



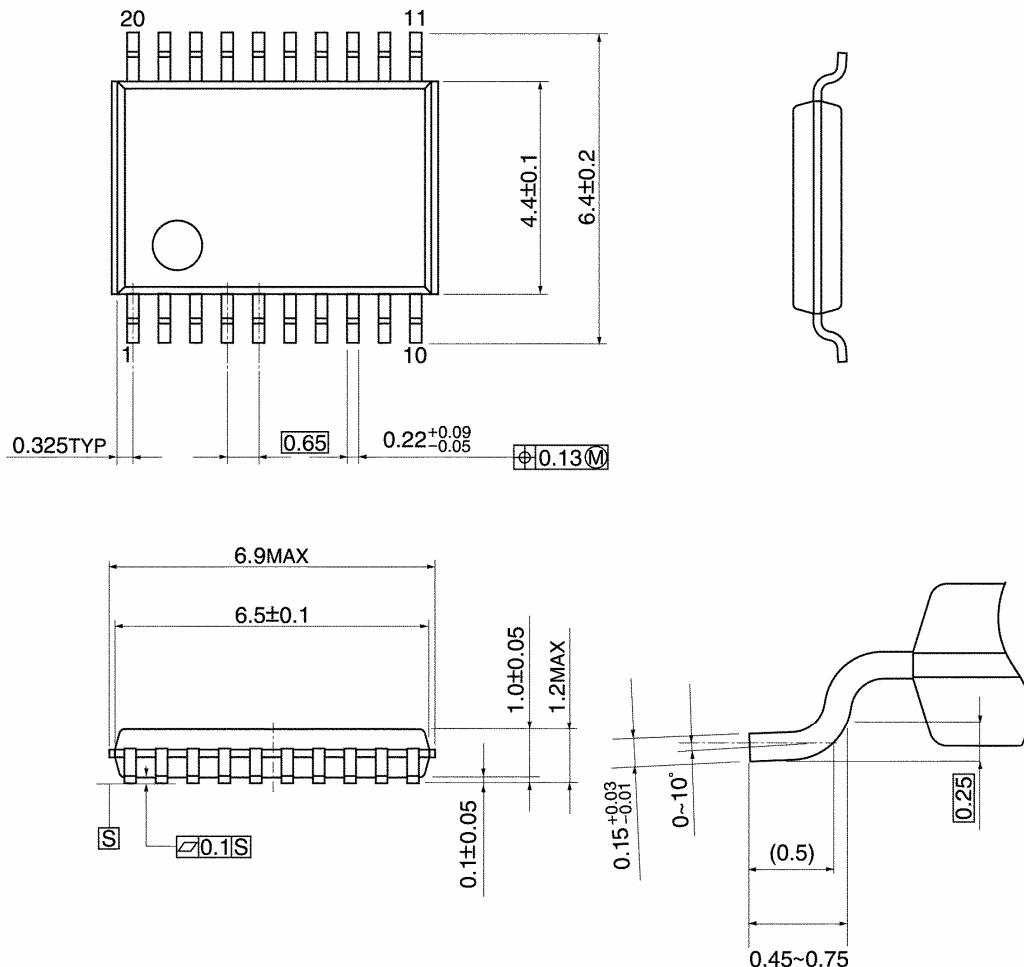
Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

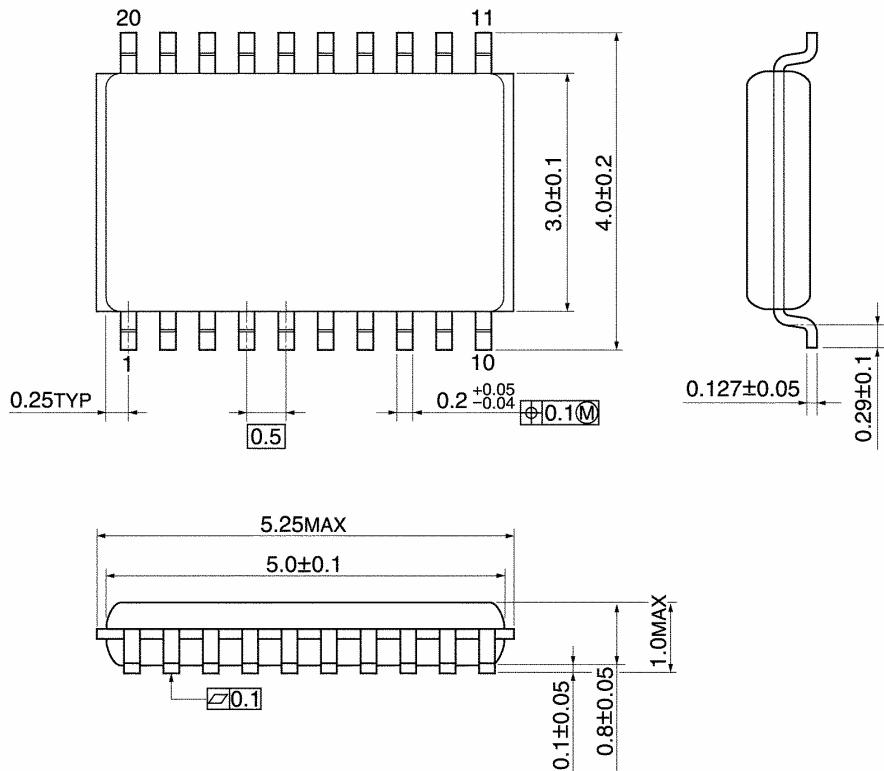


Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

Note: Lead (Pb)-Free Packages**SOP20-P-300-1.27A TSSOP20-P-0044-0.65A VSSOP20-P-0030-0.50****RESTRICTIONS ON PRODUCT USE**

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